	Material Composition Declaration © Copyright 2005. IPC, Bannockburn, Illinois. All rights reserved un international and Pan-American copyright conventions.			under both	This document is a declaration of the substances within the manufacturer listed item. Note: if the item is an assembly with low level parts, the declaration encompasses all lower level materials for which the manufacturer has engineering responsibility.										
1752-21.1					Form Type Distribute	* Declaration Class * Class 6 - RoHS Yes/No, Homogeneous Mater					als and Mfg Information				
Supplier	Information														
Company name*				Company unique ID			Unique ID Authority					Response Date*			
onsemi												2025-07-17			
Contact Na	ame	Title - Contact				Phone - Contact*				Email - Contact*					
Product-E	Env-Stewards	Product Enviro Compliance				NA				Product-Env-Stewards@onsemi.com					
Authorized	d Representative*	Title - Representative				Phone - Representative*				Email - Representative*					
Product-E	Env-Stewards	Product Enviro Compliance				NA				Product-Env-Stewards@onsemi.com					
	Requester Item Number Mfr Item J109		Number Mfr Item Name				Effective Dat	Date Version Manufacturing Site			Weight*	UOM	Unit Type		
				NFET/S TO-92			2025-07-17 CNF				219.001 mg		Each		
Manufac	cturing Proccess Informa	tion		1			1							I	-
	Terminal Plating / Grid Array Material		Ferminal Base Alloy J-STD-		J-STD-020 MSI	L Rating	Peak Proces		ss Body Temperature Max Time at Pea		Гіте at Peak	k Temperature Number		nber of Reflow Cyc	cles
Matte Tin (Sn) - annealed			CU Alloy NA				0 C 30			seconds 3					
Comments															
or more i	nformation regarding material	composition	please refer to	page 3											

RoHS Material Composition Declaration				Declaration Type *	Detailed								
Directive 2015/863/EU amending RoHS Directive 2011/65/EU													
cadmium, hexavalentchromium, polybrominate contains a RoHS restricted substance inexcess encompass all such components. Supplier certif as of the date that Supplier completes this form Company acknowledges that Supplier may hav independently verified information provided by certification in this paragraph. If the Company a	ed biphenyls and/or polybrominated dip of an applicable quantity limit, please ir ies that it gathered the information it pro- .Supplier acknowledges that Company e relied on informationprovided by othe y others, Supplier agrees that, at a minin and the Supplier enter into a written agre pource of the Supplier's liability and the	henyl ethers (each a " ndicate below which, i ovides in this form us will rely on this certifiers in completing this num, itssuppliers have eement with respect to Company's remedies	RoHS restricted substance") in exce if any, RoHS exemption you believe ing appropriate methods to ensure if ication in determining the complian form, and that Supplier may not have e provided certifications regarding the to the identified part, the terms and cc for issues that arise regarding inform	ce of its products with European Union membe	ove. If a homogeneous material within the part er level components, the declaration shall l correct to the best of its knowledge and belief, r state laws that implement the RoHS Directive. wever, in situations where Supplier has not tions are at least as comprehensive as the anty rights and/or remedies provided as part of								
RoHS Declaration * 1 - Item(s)	does not contain RoHS restricted substa	ances per the definitio	on above	Supplier Acceptance	* Accepted								
Exemption: If the declared item does not con applicable exemptions.	ntain RoHS restricted substances per	the definition above	except for defined RoHS exempti	ons, then select the corresponding response i	n the RoHS Declaration above and choose all								
Exemption List Version	EL-2011/534/EU												
Declaration Signature													
Instructions: Complete all of the required fin Requester) and click on Submit Form to have	elds on all pages of this form. Select the form returned to the Requester	he "Accepted" on th	e Supplier Acceptance drop-down	. This will display the signature area. Digital	lly sign the declaration (if required by the								
Supplier Digital Signature Ra	stislav Drska	Le											

Homogeneous Material Composition Declaration for Electronic Products

SubItem Instructions: The presence of any JIG Level A or B substances must be declared. [1] indicate the subpart in which the substance is located, [2] provide a description of the homogeneous material [3], enter the weight of the homogeneous material.

sigma range of distribution unless otherwise noted).										
Homogeneous Material	Weight	Unit of Measure	Level	Substance	CAS	Exempt	Weight	Unit of Measure		
Die	0.075	mg	Supplier	Silicon (Si)	7440-21-3		0.075	mg		
Lead Frame	101.0	mg	Supplier	Silver (Ag)	7440-22-4		0.0101	mg		
			Supplier	Iron (Fe)	7439-89-6		0.101	mg		
			Supplier	Copper (Cu)	7440-50-8		100.8586	mg		
			Supplier	Phosphorus (P)	7723-14-0		0.0303	mg		
Mold Compound-Black	112.0	mg		Phenol Resin	proprietary data		11.2	mg		
			Supplier	Carbon Black (C)	1333-86-4		1.12	mg		
			Supplier	Fused Silica (SiO2)	60676-86-0		86.24	mg		
			Supplier	Ortho-Cresol Novolac Resin	29690-82-2		13.44	mg		
Plating	5.85	mg	Supplier	Tin (Sn)	7440-31-5		5.85	mg		
Wire Bond - Au	0.076	mg	Supplier	Gold (Au)	7440-57-5		0.076	mg		

Substance Instructions: [A] select the Level (JIG A, JIG B, Requester or Supplier) [B] select the substance category (JIG or Requester) or enter a value (Supplier). [C] select the substance (JIG) or enter the substance and CAS (Other). [D] select a RoHS exemption, if applicable [E] enter the weight of the substance or the PPM concentration [F] Optionally enter the positive (+) and negative (-) tolerance in percent (Note: percent tolerance values are expected to cover a 3 signa range of distribution unless otherwise noted).